

Fig. 1

BEST AVAILABLE COPY

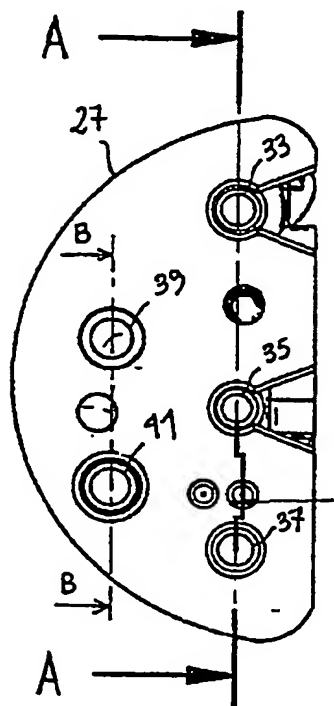


Fig. 2

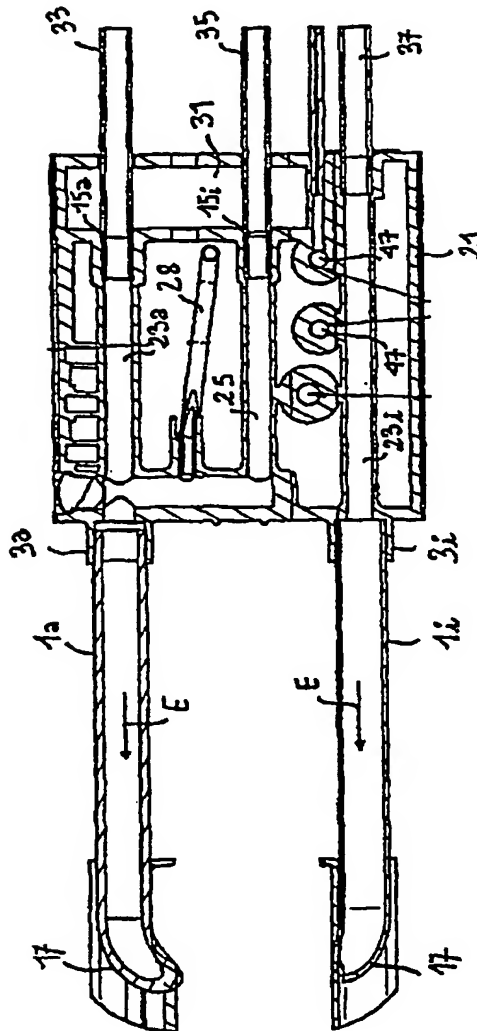


Fig. 3



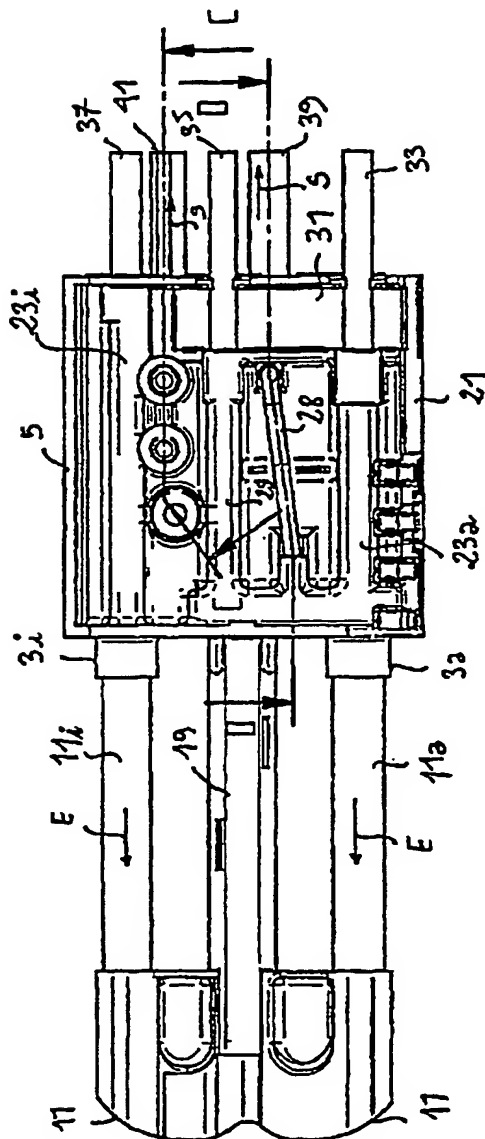


Fig. 5

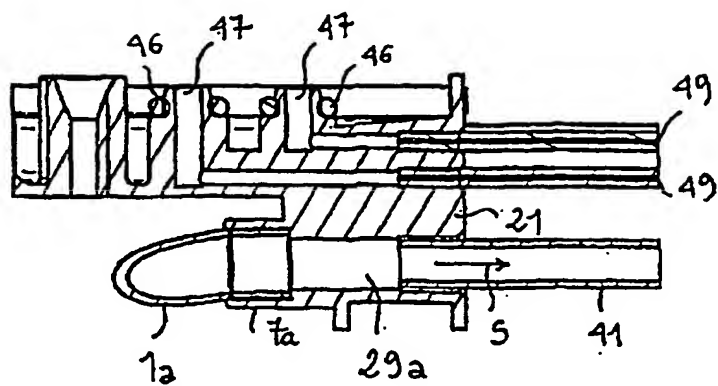


Fig. 6

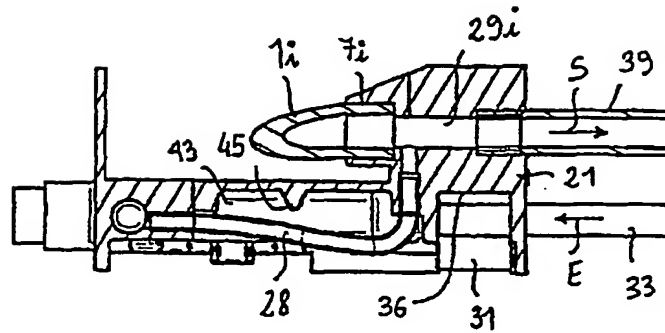


Fig. 7



Fig. 9

WO 2005/084728

10/18

PCT/CH2005/000123

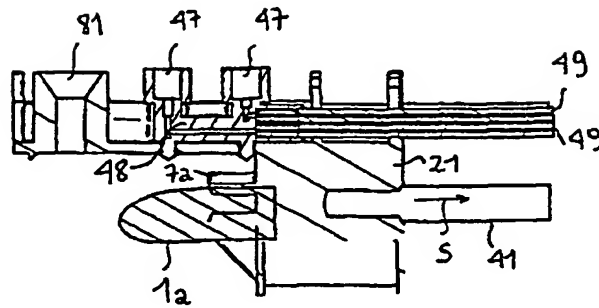


Fig. 10

WO 2005/084728

11/18

PCT/CH2005/000123

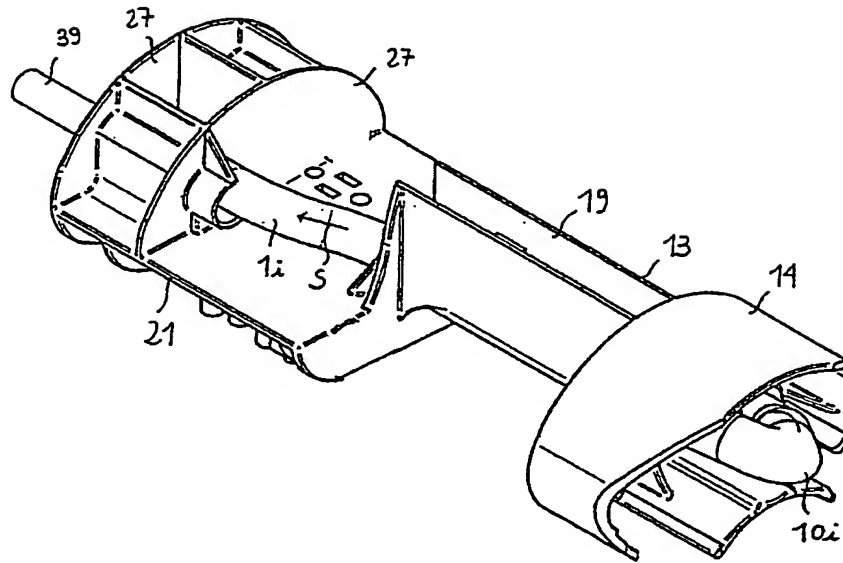


Fig. 11

WO 2005/084728

12/18

PCT/CH2005/000123

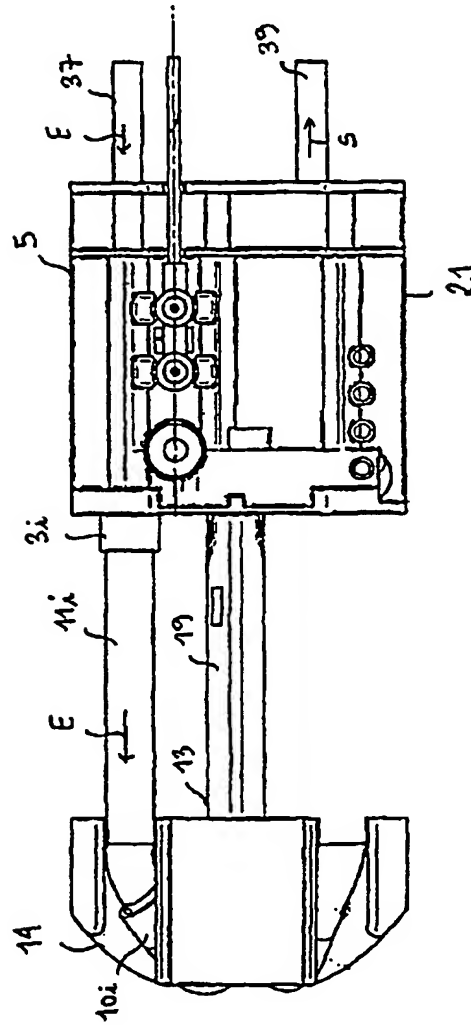


Fig. 12

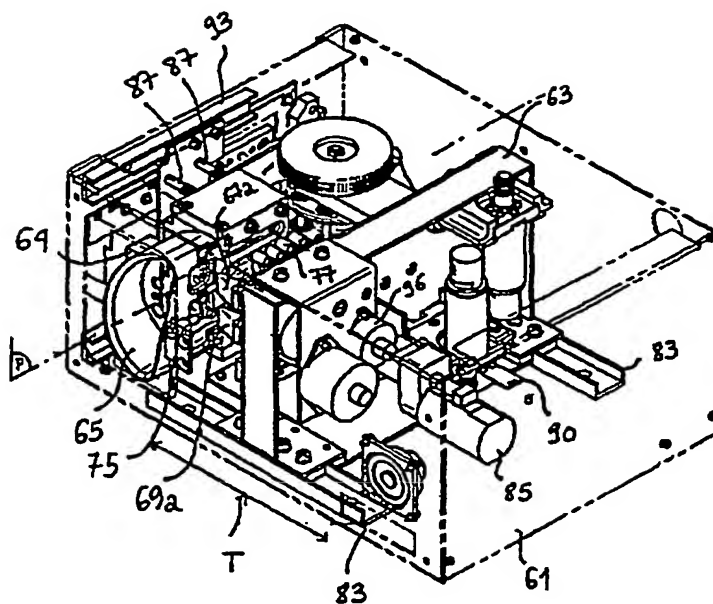


Fig. 13

WO 2005/084728

14/18

PCT/CH2005/000123

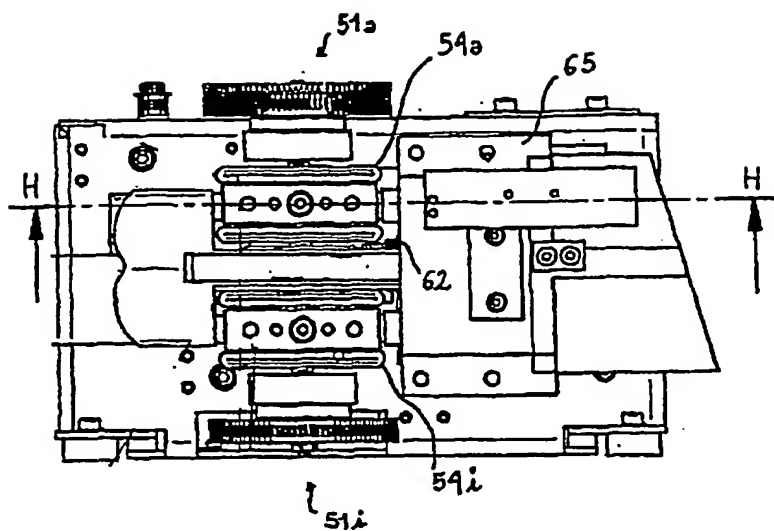


Fig. 14

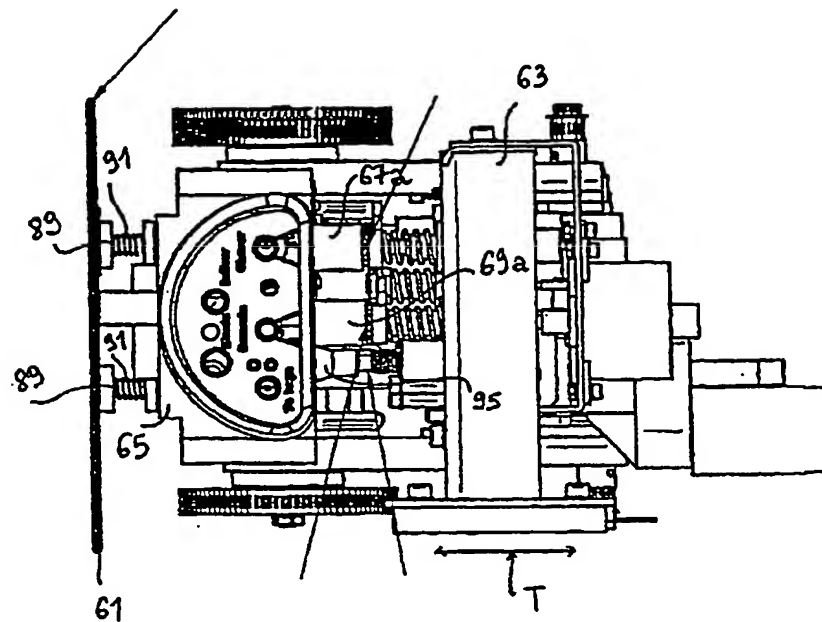


Fig. 15

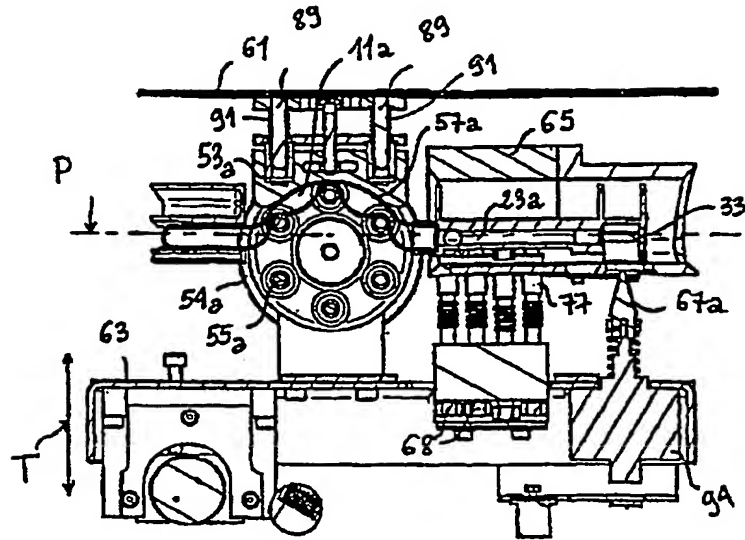


Fig. 16

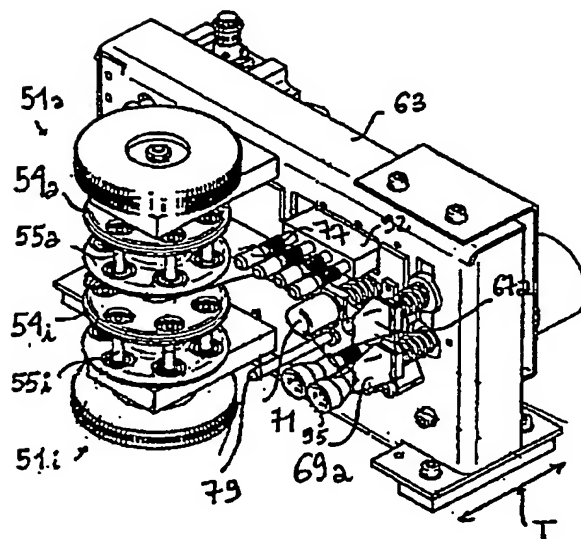


Fig. 17

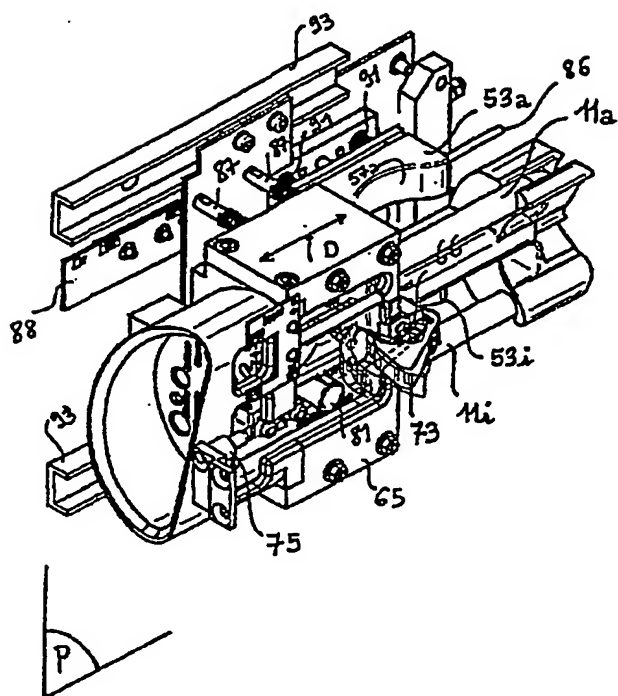


Fig. 18